

Title (en)

POLYMERIC EPOXY RESIN COMPOSITION

Title (de)

POLYMER EPOXIDHARZ-ZUSAMMENSETZUNG

Title (fr)

COMPOSITION DE RESINE EPOXY POLYMERÉ

Publication

EP 1601706 A1 20051207 (DE)

Application

EP 04714274 A 20040225

Priority

- EP 2004001871 W 20040225
- EP 03005538 A 20030311
- EP 03005377 A 20030312
- EP 04714274 A 20040225

Abstract (en)

[origin: EP1457509A1] Polymeric compositions (I) based on (a) epoxy resin(s) and (b) copolymer(s) with a glass transition point (Tg) of -20[deg]C or lower with groups which react with epoxides, also contain (c) nano-particles with an average particle size (d-max) of 5-150 nm as measured by small angle neutron scattering (SANS). Independent claims are also included for adhesives, composites, coatings and casting compounds containing (I).

IPC 1-7

C08G 59/00; C08L 63/00; C08K 3/00

IPC 8 full level

C08G 59/00 (2006.01); **C08G 59/18** (2006.01); **C08G 59/40** (2006.01); **C08G 59/58** (2006.01); **C08J 5/00** (2006.01); **C08K 3/00** (2006.01);
C08L 63/00 (2006.01); **H05K 1/03** (2006.01); **C08K 3/36** (2006.01)

CPC (source: EP US)

B82Y 30/00 (2013.01 - EP US); **C08G 59/186** (2013.01 - EP US); **C08G 59/4021** (2013.01 - EP US); **C08G 59/58** (2013.01 - EP US);
C08J 5/005 (2013.01 - EP US); **H05K 1/0373** (2013.01 - EP US); **C08J 2363/00** (2013.01 - EP US); **C08K 3/36** (2013.01 - EP US);
H05K 2201/0209 (2013.01 - EP US); **H05K 2201/0257** (2013.01 - EP US)

Citation (search report)

See references of WO 2004081076A1

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